

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: BYV27-200-TAP

Manufacturer: Vishay General Semiconductor - Diodes Division

Package: SOD-57, Axial

Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/vishay-general-semiconductor-diodes-division/byv27-200-tap.html>

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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

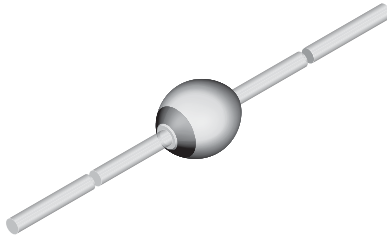
Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

Ultra-Fast Avalanche Sinterglass Diode



949539

FEATURES

- Controlled avalanche characteristic
- Low forward voltage
- Ultra fast recovery time
- Glass passivated junction
- Hermetically sealed package
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

MECHANICAL DATA

Case: SOD-57

Terminals: plated axial leads, solderable per MIL-STD-750, method 2026

Polarity: color band denotes cathode end

Mounting position: any

Weight: approx. 369 mg

APPLICATIONS

- Very fast rectification diode e.g. for switch mode power supply

ORDERING INFORMATION (Example)

DEVICE NAME	ORDERING CODE	TAPED UNITS	MINIMUM ORDER QUANTITY
BYV27-200	BYV27-200-TR	5000 per 10" tape and reel	25 000
BYV27-200	BYV27-200-TAP	5000 per ammpack	25 000

PARTS TABLE

PART	TYPE DIFFERENTIATION	PACKAGE
BYV27-50	$V_R = 50 \text{ V}$; $I_{F(AV)} = 2 \text{ A}$	SOD-57
BYV27-100	$V_R = 100 \text{ V}$; $I_{F(AV)} = 2 \text{ A}$	SOD-57
BYV27-150	$V_R = 150 \text{ V}$; $I_{F(AV)} = 2 \text{ A}$	SOD-57
BYV27-200	$V_R = 200 \text{ V}$; $I_{F(AV)} = 2 \text{ A}$	SOD-57

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Peak reverse voltage, non repetitive	See electrical characteristics	BYV27-50	V_{RSM}	55	V
		BYV27-100	V_{RSM}	110	V
		BYV27-150	V_{RSM}	165	V
		BYV27-200	V_{RSM}	220	V
Reverse voltage = repetitive peak reverse voltage	See electrical characteristics	BYV27-50	$V_R = V_{RRM}$	50	V
		BYV27-100	$V_R = V_{RRM}$	100	V
		BYV27-150	$V_R = V_{RRM}$	150	V
		BYV27-200	$V_R = V_{RRM}$	200	V
Peak forward surge current	$t_p = 10 \text{ ms}$, half sine wave		I_{FSM}	50	A
Repetitive peak forward current			I_{FRM}	15	A
Average forward current			$I_{F(AV)}$	2	A
Pulse energy in avalanche mode, non repetitive (inductive load switch off)	$I_{(BR)R} = 1 \text{ A}$, $T_j = 175^\circ\text{C}$		E_R	20	mJ
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	$^\circ\text{C}$

MAXIMUM THERMAL RESISTANCE ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction ambient	$l = 10 \text{ mm}$, $T_L = \text{constant}$	R_{thJA}	45	K/W
	On PC board with spacing 25 mm	R_{thJA}	100	K/W

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 3\text{ A}$		V_F	-	-	1.07	V
	$I_F = 3\text{ A}, T_j = 175\text{ }^{\circ}\text{C}$		V_F	-	-	0.88	V
Reverse current	$V_R = V_{RRM}$		I_R	-	-	1	μA
	V_{RSM}		I_R	-	-	100	μA
	$V_R = V_{RRM}, T_j = 165\text{ }^{\circ}\text{C}$		I_R	-	-	150	μA
Reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1\text{ A}, I_R = 0.25\text{ A}$		t_{rr}	-	-	25	ns

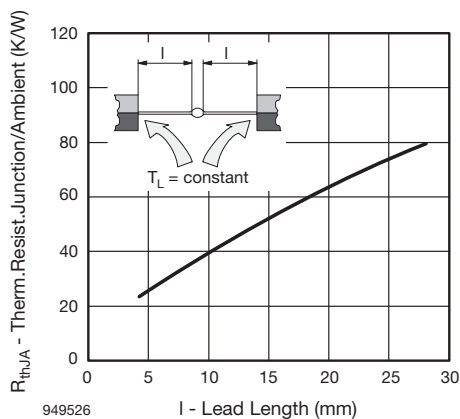
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Typ. Thermal Resistance vs. Lead Length

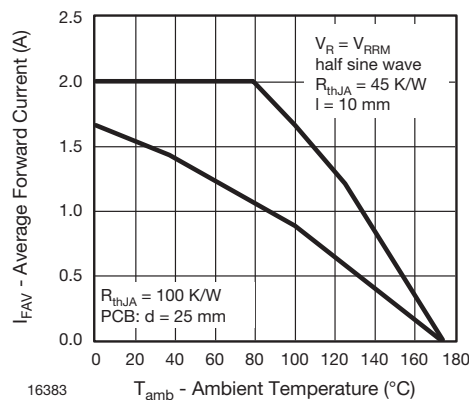


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

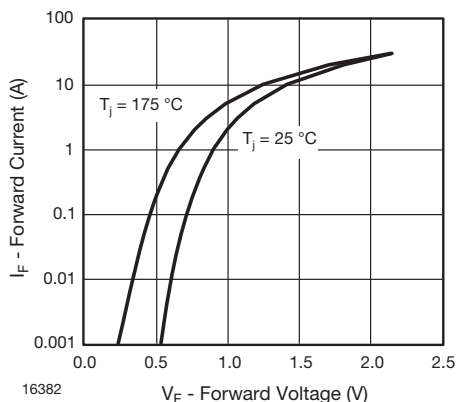


Fig. 2 - Forward Current vs. Forward Voltage

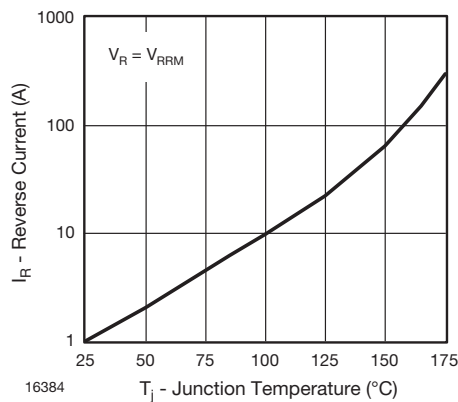


Fig. 4 - Reverse Current vs. Junction Temperature

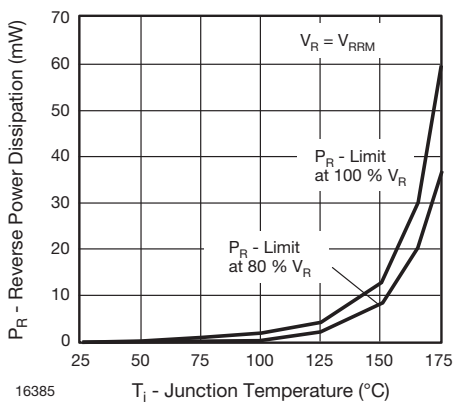


Fig. 5 - Max. Reverse Power Dissipation vs. Junction Temperature

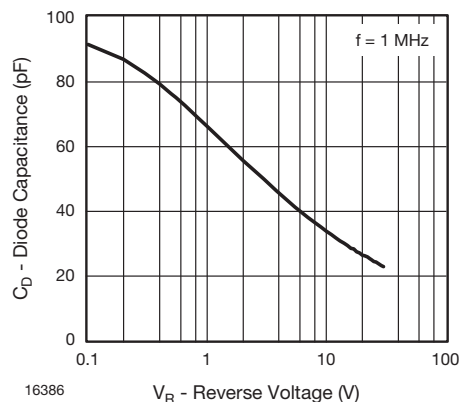
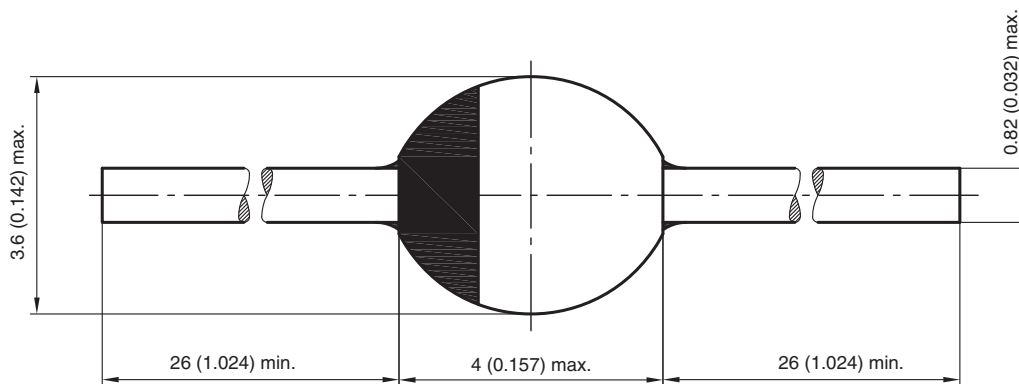


Fig. 6 - Diode Capacitance vs. Reverse Voltage

PACKAGE DIMENSIONS in millimeters (inches): **SOD-57**



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